



Standard Guide for Metallographic Sample Preparation of Cemented Tungsten Carbides¹

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1. Scope*

1.1 This guide prescribes a method for preparing cemented carbides for metallographic examination.

1.2 *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety and health practices and determine the applicability of regulatory limitations prior to use.*

2. Referenced Documents

2.1 *ASTM Standards:*²

B390 Practice for Evaluating Apparent Grain Size and Distribution of Cemented Tungsten Carbides (Withdrawn 2010)³

B657 Guide for Metallographic Identification of Microstructure in Cemented Carbides

3. Significance and Use

3.1 This sample preparation procedure may be used to prepare metallographic samples for Test Method **B657** and Practice **B390**. It does not include all variations of sample preparation.

4. Selection of Specimen

4.1 Cemented tungsten carbides are very often in the form of relatively small pieces; it is possible to select and mount the entire piece in such manner as to permit examination of the entire cross section. When pieces are too large for this, however, they should be sectioned, using a diamond cutoff wheel, to allow viewing as much of a representative cross

section as possible. For micrographs, the area selected should represent, as nearly as possible, the entire cross section.

5. Procedure

5.1 There are several acceptable methods for preparing cemented tungsten carbide surfaces for microscopical examination. Basically, they all use diamond wheels for grinding and diamond powders for lapping. The grinding practices differ, to a minor degree, with respect to grit size of diamond. In all practices, however, the final polish is produced by extremely fine diamond powder lapping, and in all practices care must be exercised to retain the microstructure in its true form and to avoid pull-out of the softer matrix material (usually cobalt). While it is accepted that other procedures may be used successfully, this procedure has proved satisfactory in many laboratories.

5.1.1 *Mounting*—Where possible, specimens should be mounted in a plastic material such as phenol-formaldehyde or poly(methyl methacrylate) to facilitate polishing without rounding the edges. Larger specimens may be polished without mounting. When specimens are too large they may be sectioned using a diamond cut-off wheel or they may be fractured (appropriate safety precautions should be used when fracturing specimens). The area selected for examination should represent, as nearly as possible, the entire cross section.

5.1.2 *Rough Grinding*—The surface to be examined may be ground flat on a surface grinder with a resin-bonded diamond wheel (100 to 220 grit) operated at 5000 to 5500 surface feet per minute (25 to 28 m/s). After the surface is flat, several clean-up passes are required; the maximum depth of cut should be 0.0005 in. (13 μ m) per pass and copious amounts of coolant should be used.

5.1.3 *Polishing*—Polishing in three steps using diamond powder or paste on a synthetic short-napped cloth (the reverse side of photographic paper, or manila file folders may also be used). When automatic polishing equipment is used, a resin-bonded diamond disk may be substituted in the roughing lap. For manual polishing, speeds of 500 to 600 rpm should be used; automatic polishing generally requires speeds of 100 to 200 rpm.

¹ This guide is under the jurisdiction of ASTM Committee B09 on Metal Powders and Metal Powder Products and is the direct responsibility of Subcommittee B09.06 on Cemented Carbides.

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² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

³ The last approved version of this historical standard is referenced on www.astm.org.

*A Summary of Changes section appears at the end of this standard



5.1.3.1 *Roughing Lap*—For the roughing lap, use NIST Grade 20 diamond powder⁴ (15 to 25 μm) dispersed in light spindle oil. Commercial diamond paste and thinner will provide similar results.

5.1.3.2 *Second Lap*—For the second lap, use Grade 6 diamond powder (4 to 8 μm) or an equivalent paste.

⁴ Available from National Institute of Standards and Technology (NIST), 100 Bureau Dr., Stop 1070, Gaithersburg, MD 20899-1070, <http://www.nist.gov>.

5.1.3.3 *Finishing Lap*—For the finish lap, use Grade 1 diamond powder (less than 2 μm) or an equivalent paste.

NOTE 1—Best results are obtained by applying considerable pressure to the specimen in all lapping operations. Lack of adequate pressure will result in pulling out the softer matrix material. It is also essential that the specimen and operator's hands be thoroughly cleaned between all grinding or polishing steps; ultrasonic cleaning is recommended.

6. Keywords

6.1 cemented carbides; cemented tungsten carbides; microstructure

SUMMARY OF CHANGES

Committee B9 has identified the location of selected changes to this standard since the last issue (B665–03) that may impact the use of this standard.

- (1) Deleted Section 6 on Precision and Bias as this statement is not appropriate for a Guide. (2) Added Summary of Changes.

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